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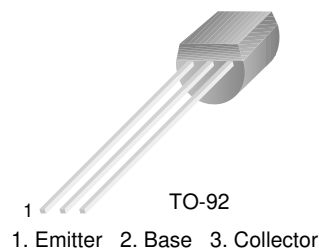
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MPS6513

NPN General Purpose Amplifier

- This device is designed as a general purpose amplifier and switch.
- The useful dynamic range extends to 100mA as a switch and to 100MHz as an amplifier.
- Sourced from Procs 23.



Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------|--|-----------|------------------|
| V_{CBO} | Collector-Base Voltage | 40 | V |
| V_{CEO} | Collector-Emitter Voltage | 30 | V |
| V_{EBO} | Emitter-Base Voltage | 4 | V |
| I_C | Collector Current (DC) | 200 | mA |
| T_J, T_{STG} | Operating and Storage Junction Temperature Range | -55 ~ 150 | $^\circ\text{C}$ |

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1. These ratings are based on a maximum junction temperature of 150 degrees C.
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Max. | Units |
|-----------------|---|------------|----------------------------|
| P_D | Total Device Dissipation Derate above 25°C | 625 5.0 | mW mW/ $^\circ\text{C}$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 83.3 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 200 | $^\circ\text{C}/\text{W}$ |

*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06".

Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---------------|--------------------------------------|--|----------|------|-------------|---------------|
| BV_{CBO} | Collector-Base Voltage | $I_C = 10 \mu\text{A}$ | 40 | | | V |
| BV_{CEO} | Collector-Emitter Voltage | $I_C = 0.5 \text{ mA}$ | 30 | | | V |
| BV_{EBO} | Emitter-Base Voltage | $I_E = 10 \mu\text{A}$ | 4 | | | V |
| I_{CBO} | Collector-Base Cut-off Current | $V_{CB} = 30 \text{ V}, T = 25^\circ\text{C}$ $T = 60^\circ\text{C}$ | | | 0.05 1.0 | μA |
| h_{FE} | DC Current Gain | $V_{CE} = 10\text{V}, I_C = 2\text{mA}$ $V_{CE} = 10\text{V}, I_C = 100\text{mA}$ | 90 60 | | 180 | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_C = 50 \text{ mA}, I_B = 5 \text{ mA}$ | | | 0.5 | V |
| C_{ob} | Output Capacitance | $V_{CB} = 5\text{V}, f = 1.0 \text{ MHz}$ | | | 3.5 | pF |



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|--------------------------|------------------------|--|
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